Kingbright

AA2214VRBXS/A-TR-AMT

2.2 x 1.4 mm Surface Mount LED Lamp

DESCRIPTIONS

- The source color devices are made with InGaN Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 2.2 mm x 1.4 mm, 1.3 mm high
- Low power consumption
- Available on tape and reel
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

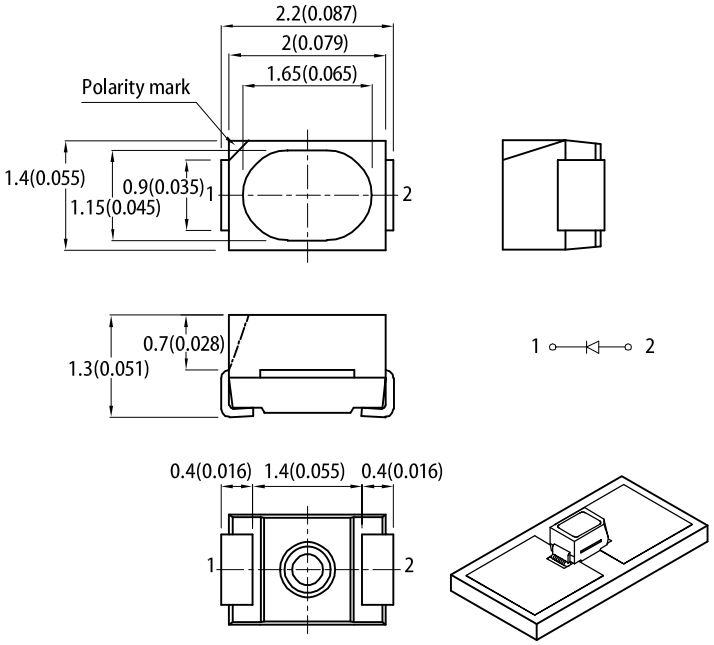
APPLICATIONS

- Traffic signaling
- Backlighting (illuminated advertising , general lighting)
- Interior and exterior automotive lighting
- Substitution of micro incandescent lamps
- Reading lamps
- Signal and symbol luminaire for orientation
- Marker lights (e.g. Steps, exit ways, etc)
- Decorative and entertainment lighting
- Indoor and outdoor commercial and residential architectural lighting

ATTENTION

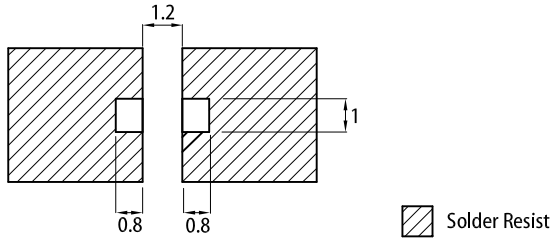
Observe precautions for handling electrostatic discharge sensitive devices

PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes:
1. *All dimensions are in millimeters (inches).*
2. *Tolerance is ±0.2(0.008") unless otherwise noted.*
3. *The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.*
4. *The device has a single mounting surface. The device must be mounted according to the specifications.*

SELECTION GUIDE

Part Number	Emitting Color (Material)	Iv (mcd) @ 20mA [2]			Viewing Angle [1]
		Code.	Min.	Max.	2θ1/2
AA2214VRBXS/A-TR-AMT	Blue (InGaN)	T	700	1000	120°
		U	1000	1300	
		V	1300	1600	

Notes:
1. *θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.*
2. *Luminous intensity / luminous flux: +/-15%.*
3. *Luminous intensity value is traceable to CIE127-2007 standards.*

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Chromaticity Coordinates x I_F = 20mA	x [1]	Blue	0.19	-	-
Chromaticity Coordinates y I_F = 20mA	y [1]	Blue	0.26	-	-
Capacitance	C	Blue	100	-	pF
Forward Voltage I_F = 20mA	V_F [2]	Blue	3.3	4.0	V
Reverse Current (V_R = 5V)	I_R	Blue	-	50	uA
Temperature Coefficient of x I_F = 20mA, -10°C ≤ T ≤ 100°C	TC_x	Blue	-0.16	-	10^{-3}/°C
Temperature Coefficient of y I_F = 20mA, -10°C ≤ T ≤ 100°C	TC_y	Blue	-0.18	-	10^{-3}/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C ≤ T ≤ 100°C	TC_V	Blue	-3.0	-	mV/°C

Notes:
1. Measurement tolerance of the chromaticity coordinates is ±0.01.
2. Forward voltage: ±0.1V.
3. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

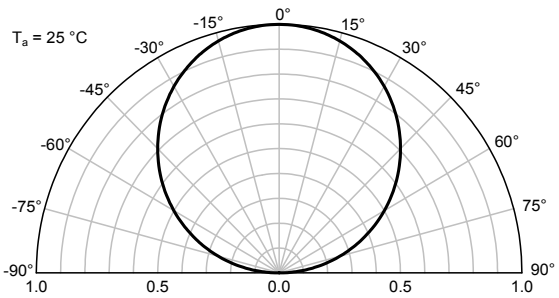
ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	120	mW
Reverse Voltage	V_R	5	V
Junction Temperature	T_j	100	°C
Operating Temperature	T_{op}	-40 to +100	°C
Storage Temperature	T_{stg}	-40 to +110	°C
DC Forward Current	I_F	30	mA
Peak Forward Current	I_{FM} [1]	100	mA
Electrostatic Discharge Threshold (HBM)	-	250	V
Thermal Resistance (Junction / Ambient)	$R_{th\ JA}$ [2]	330	°C/W
Thermal Resistance (Junction / Solder point)	$R_{th\ JS}$ [2]	215	°C/W

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. $R_{th\ JA}$,$R_{th\ JS}$ Results from mounting on PC board FR4 (pad size ≥ 16 mm^2 per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

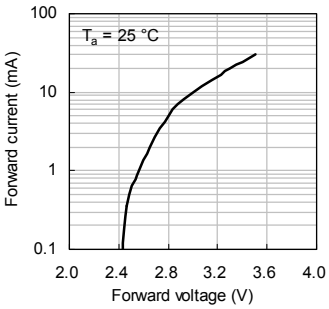
TECHNICAL DATA

SPATIAL DISTRIBUTION

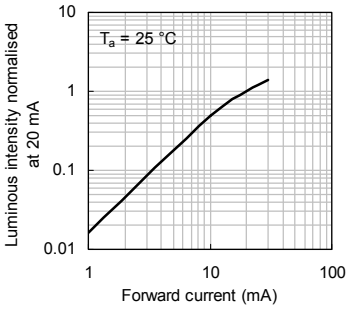


BLUE

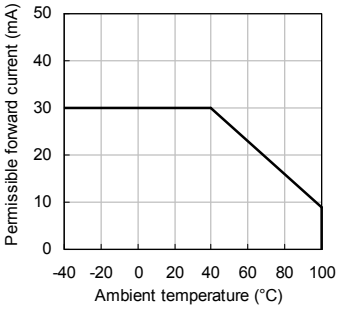
Forward Current vs. Forward Voltage



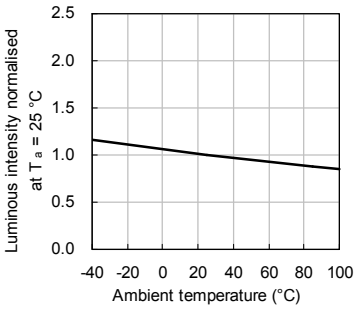
Luminous Intensity vs. Forward Current



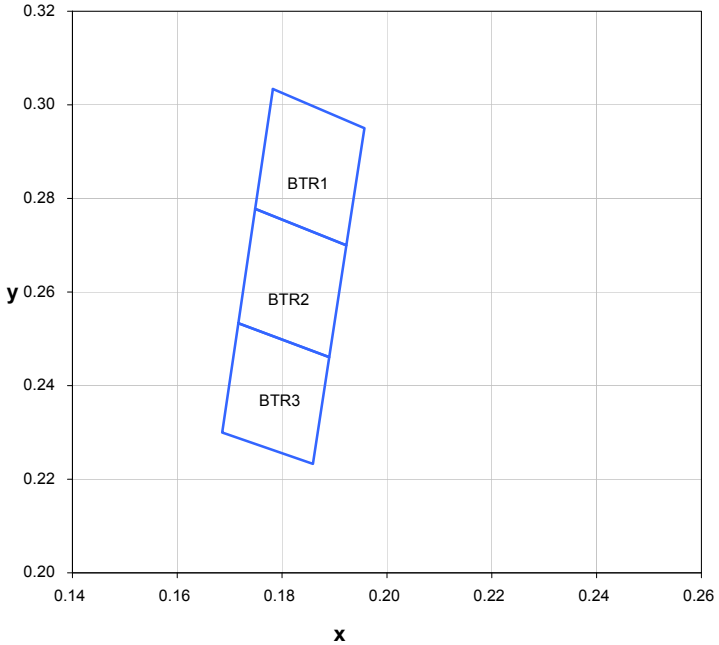
Forward Current Derating Curve



Luminous Intensity vs. Ambient Temperature



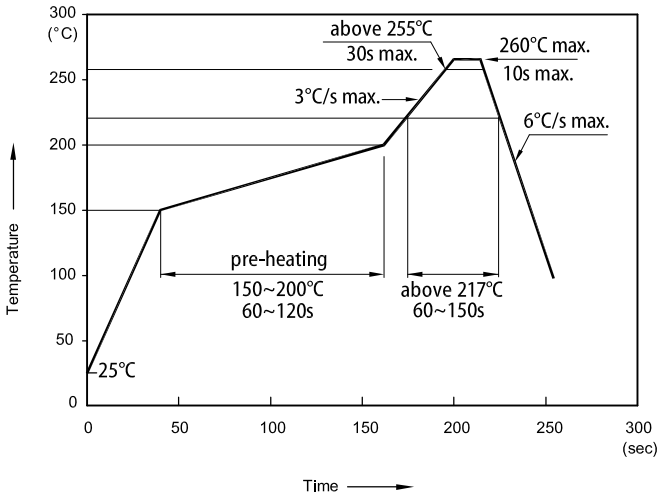
CIE CHROMATICITY DIAGRAM



	x	y
BTR1	0.1782	0.3034
	0.1749	0.2778
	0.1923	0.2700
	0.1957	0.2950
BTR2	0.1749	0.2778
	0.1716	0.2533
	0.1890	0.2461
	0.1923	0.2700
BTR3	0.1716	0.2533
	0.1686	0.2300
	0.1859	0.2233
	0.1890	0.2461

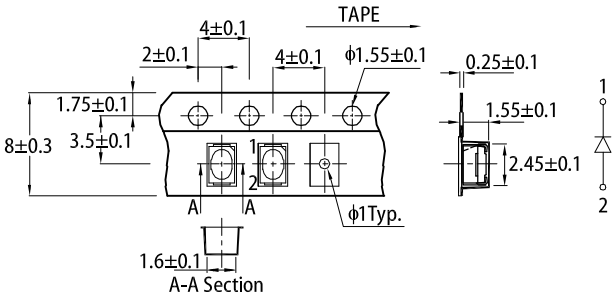
Notes:
Shipment may contain more than one chromaticity regions.
Orders for single chromaticity region are generally not accepted.
Measurement tolerance of the chromaticity coordinates is ±0.01.

REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

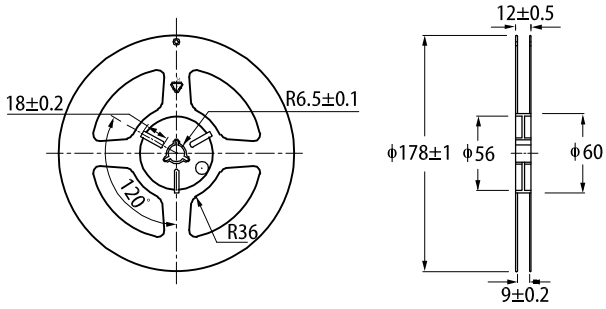


Notes:
1. Don't cause stress to the LEDs while it is exposed to high temperature.
2. The maximum number of reflow soldering passes is 2 times.
3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units : mm)



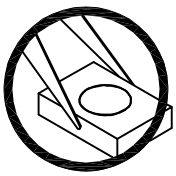
REEL DIMENSION (units : mm)



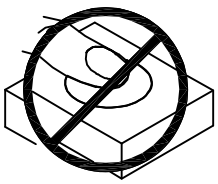
HANDLING PRECAUTIONS

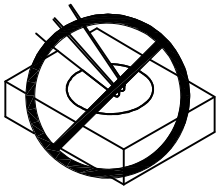
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

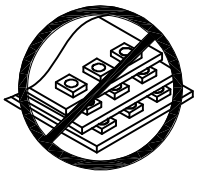


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

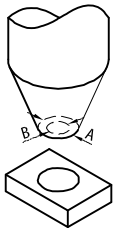




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



4-1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
4-2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
4-3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.
5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.



RELIABILITY TEST ITEMS AND CONDITIONS

The reliability of products shall be satisfied with items listed below

LOT TOLERANCE PERCENT DEFECTIVE (LTPD) : 10%

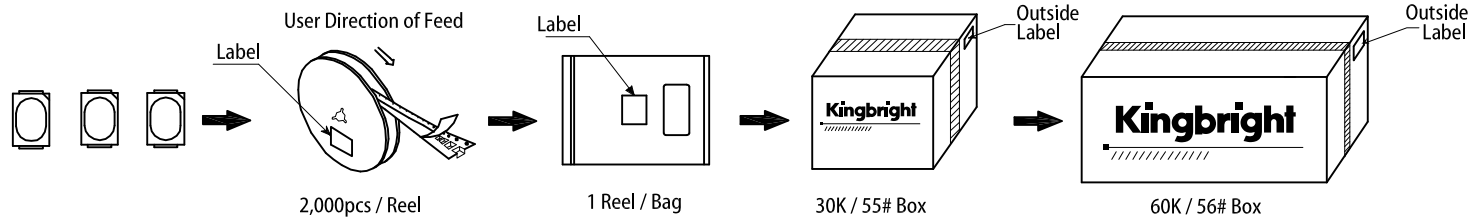
No.	Test Item	Standards	Test Condition	Test Times / Cycles	Number of Damaged
1	Continuous operating test	-	T_a = 25°C, I_F = maximum rated current *	1,000 h	0 / 22
2	High Temp. operating test	EIAJ ED-4701/100(101)	T_a = 100°C, I_F = derated current at 100°C	1,000 h	0 / 22
3	Low Temp. operating test	-	T_a = -40°C, I_F = maximum rated current *	1,000 h	0 / 22
4	High temp. storage test	EIAJ ED-4701/100(201)	T_a = maximum rated storage temperature	1,000 h	0 / 22
5	Low temp. storage test	EIAJ ED-4701/100(202)	T_a = -40°C	1,000 h	0 / 22
6	High temp. & humidity storage test	-	T_a = 60°C, RH = 90%	500 h	0 / 22
7	High temp. & humidity operating test	-	T_a = 60°C, RH = 90% I_F = derated current at 60°C	500 h	0 / 22
8	Soldering reliability test	EIAJ ED-4701/100(301)	Moisture soak: 30°C, 70% RH, 72h Preheat: 150~180°C (120s max.) Soldering temp: 260°C(10s)	2 times	0 / 18
9	Thermal shock operating test	-	T_a = -40°C(15min) ~ 100°C(15min) I_F = derated current at 100°C	1,000 cycles	0 / 22
10	Thermal shock test	-	T_a = -40°C(15min) ~ 100°C(15min)	1,000 cycles	0 / 22
11	Electric Static Discharge (ESD)	EIAJ ED-4701/100(304)	C = 100pF, R2 = 1.5KΩ V = 250V	Once each Polarity	0 / 22
12	Vibration test	-	a = 196m/s², f = 100~2KHz, t = 48min for all xyz axes	4 times	0 / 22

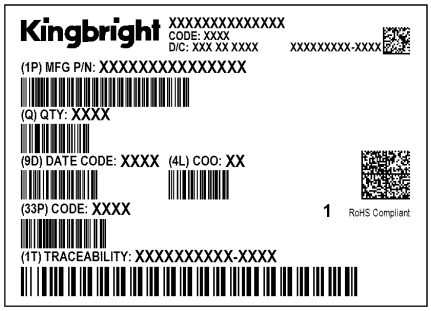
** : Refer to forward current vs. derating curve diagram*

CRITERIA FOR JUDGING DAMAGE

Items	Symbols	Conditions	Failure Criteria
luminous Intensity	I_V	I_F = 20mA	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V_F	I_F = 20mA	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I_R	V_R = Maximum Rated Reverse Voltage	Testing Max. Value ≥ Spec. Max. Value x 2.5
High temp. storage test	-	-	Occurrence of notable decoloration, deformation and cracking

PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
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